Panasonic

MAZTxxxH Series

Silicon planar type

For surge absorption circuit

Features

- Two elements anode-common type
- Power dissipation P_D : 150 mW

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation *	P _D	150	mW	
Junction temperature	Tj	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	

Note) *: $P_D = 150 \text{ mW}$ achieved with a printed circuit board.

- Package
- Pin Name SSMini3-F2
- Pin Name
- 1: Cathode 1
- 2: Cathode 2
- 3: Anode

Marking Symbol

Refer to the list of the electrical characteristics within part numbers

Internal Connection



Common Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol		Conditions	Min	Тур	Max	Unit	
Zener voltage*	VZ	IZ	Specified value					V
Zener rise operating resistance	R _{ZK}	IZ	Specified value	Refer to the list of the electrical characteristics within part numbers				Ω
Zener operating resistance	R _Z	IZ	Specified value					Ω
Reverse current	I _R	V _R	Specified value					μΑ

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Electrostatic breakdown voltage: $\pm 10 \text{ kV}$

Test method: IEC1000-4-2 (C = 150 pF, R = 330 Ω , Contact discharge: 10 times)

3. *: The temperature must be controlled 25°C for V_Z mesurement.

 V_Z value measured at other temperature must be adjusted to $V_Z\,(25^\circ C)$

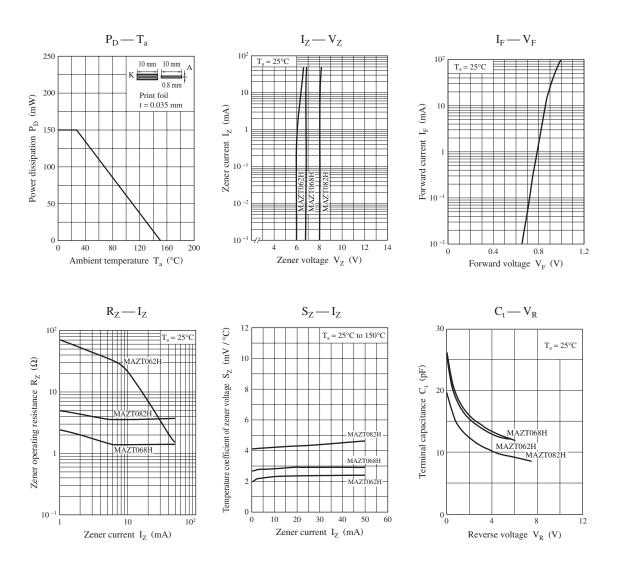
 V_Z guaranted 20 ms after current flow.

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Zener voltage			Reverse current		Zener operating resistance	Zener rise operating resistance			
Part number	Part number V _Z (V)		I _R (mA) V _R		$R_Z(\Omega)$	$R_{ZK}(\Omega)$ $I_7 = 0.5 \text{ mA}$	Marking symbol		
	Min	Nom	Max	(mA)	Max	(V)	Max	Max	
MAZT062H	5.8	6.2	6.6	5	0.2	4	50	100	6.2Z
MAZT068H	6.4	6.8	7.2	5	0.1	4	30	60	6.8Z
MAZT082H	7.7	8.2	8.7	5	0.1	5	30	60	8.2Z

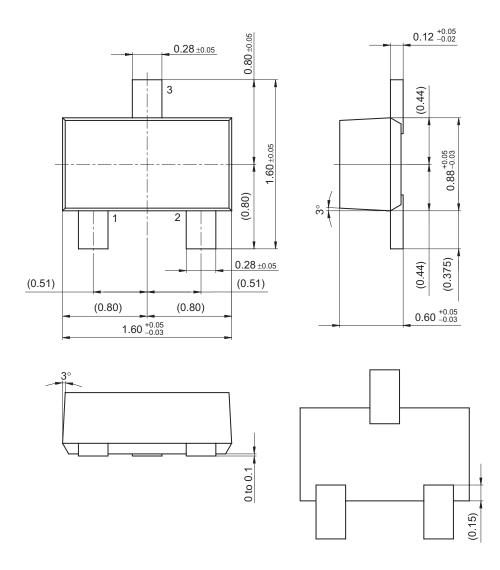
Electrical characteristics within part numbers $T_a = 25^{\circ}C \pm 3^{\circ}C$

Note) *: $I_Z = 1.0 \text{ mA}$



SSMini3-F2

Unit: mm



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